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Effective field and universal mobility in high-k metal gate UTBB-FDSOI devices.

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Abstract—This paper aims at reviewing experimental and theoretical behaviors of universal mobility in high-k metal gate UTBB-FDSOI devices. Based on split-CV mobility measurements, the parameter \( \eta \), characterizing the effective field, has been extracted for a large range of back voltages and temperatures in devices with various equivalent oxide thicknesses. We demonstrated that a nearly universal trend for the mobility with respect to the effective field can be obtained in the front inversion regime but is difficult to obtain in the back channel inversion regime.

Keywords—FDSOI, universal mobility, effective field, coefficient \( \eta \).

I. INTRODUCTION

Ultra-Thin Body and Box Fully Depleted SOI (UTBB-FDSOI) device is considered as one of the best alternative solution to overcome conventional planar Bulk CMOS limitations [1-2]. Transport properties in UTBB-FDSOI have been extensively studied and many issues have been reported concerning both, the definition of the effective field \( (E_{\text{eff}}) \) [3] and the universal behavior of the mobility [4]. This paper aims at reviewing important experimental and theoretical aspects of the universal behavior of the mobility with respect to the effective field. The parameter \( \eta \), characterizing the effective field, has been extracted from split-CV mobility measurements for n- and p-type UTBB-FDSOI devices. These extractions have been performed for a large range of Back gate Voltages (VB), temperatures and for devices with various Interfacial oxide (IL) Equivalent Oxide Thicknesses (EOT).

II. EXPERIMENTAL OBSERVATIONS

Devices have been processed on 300 nm SOI wafers with a 25 nm thick BOX. The final channel thickness is 7.5 nm and the oxide stack is made of a 1.8 nm thick layer of HiSiON high-k oxide deposited on top of a SiON interfacial layer (IL) with various physical thicknesses \( T_{\text{inv}} \) ranging from 1.3 to 4.0 nm for both n- and p- FDSOI devices. The effective mobility has been characterized using split-CV method on 0.9 x 0.9 \( \mu \text{m}^2 \) devices (measurements at \( V_{\text{DS}}=50 \text{ mV} \)) for a large range of VB ((-10 V<VB<10 V) and temperatures \((T=233, 300 \text{ and } 450 \text{ K})\). The impact of the VB on the capacitance and the drain current is shown in Figure 1 for various temperatures. Figures 2 and 3 demonstrate a non monotonic behavior and an improvement of the mobility in the forward regime (VB>0 V for nFDSOI and VB<0 V for pFDSOI devices) which is a direct consequence of the back gate inversion, as previously observed in [5-6]. The extractions have been corrected from access resistances of \( R_{\text{access}}=2 \times 60 \, \Omega.\mu\text{m} \).

The variation of the capacitance and the threshold voltage (VTH) for all devices are shown in Figures 4 and 5 respectively. It demonstrates that the VTH can be shifted by -0.5 V to 1 V for VB ranging from -10 V to 10 V. The mobility degradation observed in figure 6 in the thinner EOT device is attributed to remote coulomb scattering due to the presence of charges at high-k/IL interface [6].
The mobility extracted at fixed inversion charge as a function of VB (figure 7) exhibits a bell-shaped behavior [6]. In the next section, we show that this behavior can be further highlighted representing the mobility versus the effective field rather than as a function of the inversion density as in figure 2.

A reverse average electric field can be defined from the local concentration n(x) and the reverse field E_{ave}(x) as:

\[ E_{ave}^{th} = \frac{\int_0^1 E_x(x) n(x) dx}{\int_0^1 n(x) dx} \]  

This later equation can be approximated by the following simplified equation in UTBB-FDSOI MOSFETs [8]:

\[ E_{ave}^{exp} = \frac{Q_d \eta \epsilon_0}{\epsilon_s} - \frac{VB}{T_{eff}} \]  

with \( T_{eff} \) being the average electric field from (1) and (2), η has to be taken equal to η = 0.5 for both n- and pMOS devices in bulk [9] as well as in FDSOI structures [10].

Figure 8: n- (left) and p- (right) FDSOI average electric field (Eq.2) assuming η = 0.5 compared to the simulated theoretical average field (Eq.1). VB from -10 V to 10 V in steps of 2 V. \( T_{inv} = 2.65 \) nm; \( T = 300 \) K.

Figure 8 demonstrates that the approximated average field from Eq.2 reproduces accurately the numerical one (Eq.1) calculated using a self-consistent Poisson-Schrödinger solver for all biases.
This also provides an efficient way to calibrate parameters $T_{inv}$, $\varepsilon_{ox}$, IL EOT, $T_{BOX}$ from experiments. Another effective field $E_{eff}$ (not to be confused with the average transverse average electric field) based on Eq.2 is usually used to get the universal mobility curve [11]. In this case, $\eta$ is used as an empirical parameter and is extracted from experiments. In the case of bulk devices, this parameter has been found equal to $\eta = 0.5$ for bulk nMOSFET and $\eta = 0.33$ for bulk pMOSFET [11].

In high-k UTBB-FDSOI ($T_{inv}$ ranging from 1.3 to 4 nm), it has been demonstrated [5, 6] that the main mechanisms responsible of the mobility degradation are remote coulomb (due to the presence of charges at high-k/IL interface), phonons and surface roughness scatterings. From theoretical mobility calculation, we have shown in a previous work [5] that, in the back inversion regime or for devices with thick EOT ($T_{IL} > 2.0$ nm), the remote coulomb component does not play a significant role in the total mobility. It is thus interesting to study the impact of remote coulomb scattering on mobility curves changing VB, temperatures or IL EOT.

Using values extracted in bulk devices, the experimental mobility has been plotted in the case of FDSOI devices as a function of the effective field for various VB ranging from -10 V to 10 V (figure 9). First of all, it can be noticed that the effective field spans a much larger range of values when sweeping VB. However, it is clear from this figure that the mobility does not follow a universal trend, in particular in the back inversion regime.

A recent paper has shown that the value of $\eta$ in FDSOI devices may be different from bulk values [12]. This raises the question of the extraction of this parameter. $\eta$ is usually extracted by adjusting experimental curves in order to get the best universal trend. However, an alternative technique has been recently proposed, deducing $\eta$ from the following formula [13]:

$$ \eta_{SOI} = \frac{A C_{box}}{A C_{B} - C_{ox}} \eta \left( \frac{\partial \eta_{eff}}{\partial V_{FB}} \right)_{V_{FB}} \left( \frac{\partial \eta_{eff}}{\partial V_{FB}} \right)_{V_{FB}} $$

(3)

This method (Eq.3) has been used to extract $\eta$ at $V_B=0$ V for various temperatures (figure 10), leading to $\eta = 0.42$ and 0.36 for n- and p- FDSOI devices respectively. A slight decrease of the coefficients has been observed for increasing temperatures. This can also be seen in figure 11 where $\eta$ has been characterized for devices with various IL EOT.

Using these extracted values $\eta = 0.42$ and 0.36, the experimental mobility has been plotted as a function of the effective field (figure 12). Also in this case, it turns out that the mobility does not follow a universal trend.
converge to the previously extracted values while in the back inversion regime, an increase of the coefficients with VB can be observed. As expected when the front channel is not inverted, Eq. 3 is not valid and the extraction of \( \eta \) is not relevant.

In Figure 16, \( \eta \) has been extracted for n- and pFDSOI devices (\( T_{inv}=4.0 \) nm) at various temperatures. As previously observed in Figure 10, the coefficients is not affected significantly by the temperature.

There is another aspect to mention concerning the key assumption behind Eq.3. It ought to be notified that this equation is based on the assumption that [13]:

\[
\left( \frac{\partial \mu_{\text{eff}}}{\partial E_{\text{eff}}} \right)_{V_{bg}} = \left( \frac{\partial \mu_{\text{eff}}}{\partial E_{\text{eff}}} \right)_{V_{bg}}
\]  

(4)

In order to check the validity of this formula, in figures 17, 18 and 19, the mobility has been plotted with respect to the effective field sweeping VB at fixed VG and sweeping VG at VB=0 V. First of all, in figure 17, bulk values for \( \eta \) are used (0.5 for n- and 0.33 for pFDSOI devices) and the condition described in Eq.4 is not satisfied at high Eeff. However, the same conclusions can be obtained from figure 18 when using values extracted from Eq.3 (\( \eta = 0.42 \) and 0.36 for n- and pFDSOI devices respectively). In order to get a better agreement, \( \eta \) also has been re-extracted by brute-force numerical fitting, leading to the value of \( \eta=0.62 \) for nFDSOI and \( \eta=0.5 \) for pFDSOI devices. Results are shown in figure 19. It can be notified incidentally that the behaviors shown in figure 17, 18 and 19 have been reproduced using a Kubo-Greenwood solvers (not shown here) [5].

In Figure 17: n- and p- FDSOI experimental effective mobility as a function of the effective field sweeping the back terminal or the gate terminal. Eq.2 have been used for the evaluation of the effective field with \( \eta=0.5 \) for nFDSOI and \( \eta=0.33 \) for pFDSOI devices. \( T_{inv}=2.65 \) nm, \( T=300 \) K.
In these cases, a much better approach is to use the effective field with $\eta=0.62$ for nFDSOI and $\eta=0.5$ for pFDSOI. Effective field calculated using Eq.2. (\(\eta=0.62\)).

The mobility has been plotted as a function of effective field for n- (figure 21) and p- FDSOI (figure 22) devices with $T_{\text{inv}}=4.0$ and 1.3 nm. We can notice that for the thinnest device ($T_{\text{inv}}=1.3$ nm), where remote coulomb scattering plays a significant role, the mobility curves with respect to $E_{\text{eff}}$ do not follow an unique trend even in the front inversion regime. The impact of remote coulomb scattering is further depicted in figure 23 where the mobility has been plotted for $V_B=\pm 8$ V and 8 V for the nFDSOI devices with various IL EOT. This is also noticeable in pFDSOI devices where the remote coulomb scattering contribution to the total mobility is less pronounced.
These results confirm the difficulties to define a unique effective field in UTBB-FDSOI devices. Indeed, contrary to bulk devices, depending on gate and back voltages, carriers are not confined in a single inversion layer. The existence of multiple channels and the difference between the quality of the two interfaces (front and back) is most likely the cause of the difficulties to have a “perfect” universal trend in the whole range of effective field.

IV. CONCLUSIONS

In this paper, we have reviewed the important aspect of the effective field and mobility in UTBB-FDSOI devices. We have demonstrated that a nearly universal trend for the mobility with respect to $E_{eff}$ can be obtained only in a limited range of VB. Indeed, we showed that in forward VB conditions, a single value of $\eta$ does not make universal the mobility versus the effective field. The coexistence of multiple channels and the difference of interfaces (front and back) quality make difficult to apply the same procedure than in bulk devices for the full range of gate and back voltages.
